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The S-2812A and the S-2817A are low power 2K×8-bit parallel E<sup>2</sup>PROMs. The S-2812A features wide operating voltage range, and the S-2817A features 5-V single power supply. Since provided with 32-byte page write function, they can perform fast programming operation.

#### Features

· Access time: 150 ns

 $(V_{CC}=5 V\pm 10\%, Ta=0^{\circ}C \text{ to } 70^{\circ}C)$ 

• Low power consumption

Operating: 30 mA max. ( $V_{CC}$ =5 V±10%) Standby: 1  $\mu$ A max. ( $V_{CC}$ =5 V±10%)

• Operating voltage range

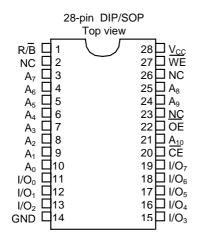
<u>S-2812A</u> <u>S-2817A</u> Read: 1.8 to 5.5 V 5 V±10% Write: 2.7 to 5.5 V 5 V±10%

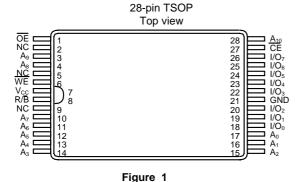
· Write inhibition

S-2812A: 2.1 V typ. S-2817A: 3.5 V typ.

- Data polling
- With Ready/Busy pin
- Page write for 32 bytes
- Rewritings: 10<sup>5</sup> times
- Data retention: 10 years
- Program noise immunity
- Package: 28-pin DIP/SOP/TSOP
- · Supply in bare chip is also available

### ■ Pin Assignment

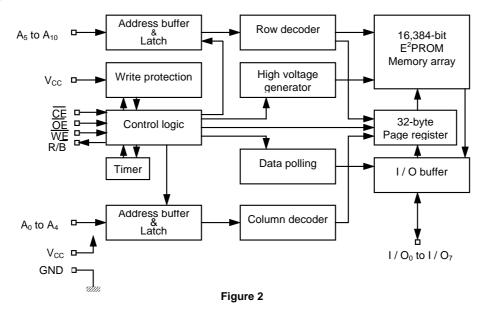




Pin name Function  $A_0$  to  $A_{10}$ Address input  $I/O_0$  to  $I/O_7$ Data input / output CE Chip Enable ŌE **Output Enable** WE Write Enable R/B Ready/Busy (opendrain output) Power supply voltage  $V_{CC}$ **GND** Ground (0 V)

**J** ...

## **■ Block Diagram**



# **■** Operation Mode

Table 1

Mode	CE	OE	WE	I/O
Read	L	L	Н	Data output
Write	L	Н	L	Data input
Write inhibition	×	×	Η	_
Will minbillon	×	L	×	_
Standby	Н	×	×	High-Z

x:Don't care

# ■ Absolute Maximum Ratings

Table 2

Parameter	Symbol	Ratings	Unit
Power supply voltage	V <sub>CC</sub>	-0.3 to +7.0	V
Input voltage	$V_{IN}$	-0.3 to V <sub>CC</sub> +0.3	V
Output voltage	V <sub>OUT</sub>	-0.3 to $V_{CC}$	V
Storage temperature under bias	$T_{bias}$	-50 to +95	°C
Storage temperature	$T_{stg}$	-65 to +150	°C

# **■** Recommended Operating Conditions

Table 3

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Power supply voltage	V <sub>CC</sub>	S-2812A	Read	1.8		5.5	V
			Write	2.7		5.5	V
		S-2817A		4.5	5.0	5.5	V
High level input voltage	V <sub>IH</sub>	$V_{CC}$ =2.7 to	5.5 V	2.2		V <sub>CC</sub> +0.3	V
		V <sub>CC</sub> =1.8 to 2.7 V		0.8×V <sub>CC</sub>		V <sub>CC</sub> +0.3	٧
Low level input voltage	$V_{IL}$	V <sub>CC</sub> =5 V ±1	0%	-0.3		0.8	V
		V <sub>CC</sub> =2.7 to	V <sub>CC</sub> =2.7 to 4.5 V		_	0.4	V
		$V_{CC}$ =1.8 to	2.7 V	-0.3		0.2×V <sub>CC</sub>	٧
Operating temperature	$T_{opr}$			-40	_	85	°C

## ■ DC Electrical Characteristics

### 1. S-2812A

Table 4

(Ta=-40°C to 85°C)

Б	0 1 1	0 88			.,	0.1/1400/			
Parameter	Symbol	Conditions		V±109	<b>%</b>	3	V±109	%	Unit
			Min.	Тур.	Max.	Min.	Тур.	Max.	
Current consumption (Read)	I <sub>CC1</sub>	$\overline{CE} \le V_{IL}, \ V_{IN} \le V_{IL} \text{ or } V_{IN} \ge V_{IH}$ $I_{OUT} = 0 \text{ mA}, \ f = 1/t_{RC}$	_		30			15	mA
	I <sub>CC2</sub>	$\overline{\text{CE}} \le 0.2 \text{ V}, \ \ V_{\text{IN}} \le 0.2 \text{ V or } V_{\text{IN}} \ge V_{\text{CC}} - 0.2 \text{ V}$ $I_{\text{OUT}} = 0 \text{ mA}, \ \ f = 1/t_{\text{RC}}$	_	_	25	_	_	10	mA
Current consumption (Program)	I <sub>CC3</sub>	$\overline{CE} \le V_{IL}, \ V_{IN} \le V_{IL} \text{ or } V_{IN} \ge V_{IH}$	_	_	30			15	mA
	I <sub>CC4</sub>	CE≤0.2 V, V <sub>IN</sub> ≤0.2 V or V <sub>IN</sub> ≥V <sub>CC</sub> -0.2 V	_		25	-		10	mA
Standby current	I <sub>SB1</sub>	<u>C</u> E≥V <sub>IH</sub>	_	_	1	_	_	0.5	mΑ
	I <sub>SB2</sub>	CE≥V <sub>CC</sub> -0.2 V	_	_	1.0	_	_	1.0	μΑ
Input leakage current	ILI	V <sub>IN</sub> =GND to V <sub>CC</sub>	_	_	1.0	_	_	1.0	μΑ
Output leakage current	$I_{LO}$	$V_{I/O}$ =GND to $V_{CC}$		_	1.0			1.0	μΑ
High level output voltage	V <sub>OH</sub>	5-V operation: $I_{OH}$ =-400 μA 3-V operation: $I_{OH}$ =-100 μA	2.4			2.4			V
Low level output voltage	V <sub>OL</sub>	5-V operation: I <sub>OL</sub> =2.1 mA 3-V operation: I <sub>OL</sub> =400 μA			0.4			0.4	V

### 2. S-2817A

### Table 5

i able 5										
		(Ta=-40°C to 85°C, $V_{CC}$ =5 V±10%								
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit				
Current consumption (Read)	I <sub>CC1</sub>	$\overline{CE} \le V_{IL}, \ V_{IN} \le V_{IL} \text{ or } V_{IN} \ge V_{IH}$ $I_{OUT} = 0 \text{ mA}, \ f = 1/t_{RC}$			30	mA				
	I <sub>CC2</sub>	$\overline{\text{CE}} \le 0.2 \text{ V}, \ \ V_{\text{IN}} \le 0.2 \text{ V or } V_{\text{IN}} \ge V_{\text{CC}} - 0.2 \text{ V}$ $I_{\text{OUT}} = 0 \text{ mA}, \ \ f = 1/t_{\text{RC}}$			25	mA				
Current consumption (Program)	I <sub>CC3</sub>	$\overline{CE} \le V_{IL}, \ V_{IN} \le V_{IL} \text{ or } V_{IN} \ge V_{IH}$			30	mA				
	$I_{CC4}$	 CE≤0.2 V, V <sub>IN</sub> ≤0.2 V or V <sub>IN</sub> ≥V <sub>CC</sub> -0.2 V	_	_	25	mΑ				
Standby current	I <sub>SB1</sub>	CE≥V <sub>IH</sub>	_	_	1	mA				
	I <sub>SB2</sub>	CE≥V <sub>CC</sub> -0.2 V	_	_	1.0	μΑ				
Input leakage current	ILI	$V_{IN}$ =GND to $V_{CC}$	_	_	1.0	μΑ				
Output leakage current	$I_{LO}$	$V_{I/O}$ =GND to $V_{CC}$	-	-	1.0	μΑ				
High level output voltage	$V_{OH}$	Ι <sub>ΟΗ</sub> =-400 μΑ	2.4			V				
Low level output voltage	$V_{OL}$	I <sub>OL</sub> =2.1 mA			0.4	V				

# ■ Rewriting Times

## Table 6

Parameter	Symbol	Min.	Тур.	Max.	Unit
Rewriting times	$N_W$	10 <sup>5</sup>			times/byte

# ■ Pin Capacitance

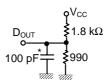
# Table 7

	Table 1											
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit						
Input capacitance	C <sub>IN</sub>	V <sub>IN</sub> =0 V	_	_	10	pF						
Input / output	C <sub>I/O</sub>	V <sub>I/O</sub> =0 V	_		10	pF						

# ■ AC Electrical Characteristics

Table 8 Measuring conditions

Parameter	S-2812A	S-2817A
Input pulse levels	V <sub>IL</sub> =0.2 V V <sub>IH</sub> =2.4 V	V <sub>IL</sub> =0.4 V V <sub>IH</sub> =2.4 V
Input rise and fall time	10 ns	10 ns
I/O reference level	1.5 V	1.5 V
Output load	See Figure 3	See Figure 3



\* (When measuring  $t_{\text{CLZ}},\,t_{\text{OLZ}},\,t_{\text{CHZ}},\,t_{\text{OHZ}},\\t_{\text{WHZ}},\,t_{\text{WLZ}})$  : 5pF

Figure 3 Output load measuring circuit

# 1. Read Cycle

(1) 5-V operation

Table 9

(V<sub>CC</sub>=5 V±10%)

Parameter	Symbol	0°C to 70°C		-40°C to 85°C		Unit
		Min.	Max.	Min.	Max.	
Read cycle time	t <sub>RC</sub>	150	_	200	_	ns
CE access time	t <sub>CE</sub>	_	150	_	200	ns
Address access time	t <sub>AA</sub>		150		200	ns
OE access time	t <sub>OE</sub>		70	_	90	ns
Output enable time (CE)	t <sub>CLZ</sub>	10		10	_	ns
Output enable time (OE)	t <sub>OLZ</sub>	10		10	_	ns
Output disable time (CE)	t <sub>CHZ</sub>	10	70	10	90	ns
Output disable time (OE)	t <sub>OHZ</sub>	10	70	10	90	ns
Output data hold time	t <sub>OH</sub>	5	_	5		ns

# (2) 3-V operation (S-2812A only)

Table 10

(V<sub>CC</sub>=3 V±10%)

Parameter	Symbol	0°C to 70°C		-40°C to 85°C		Unit
		Min.	Max.	Min.	Max.	
Read cycle time	t <sub>RC</sub>	400	—	500	_	ns
CE access time	t <sub>CE</sub>		400	_	500	ns
Address access time	t <sub>AA</sub>	1	400		500	ns
OE access time	t <sub>OE</sub>		200		250	ns
Output enable time (CE)	t <sub>CLZ</sub>	25	_	30	_	ns
Output enable time (OE)	t <sub>OLZ</sub>	25	_	30		ns
Output disable time (CE)	t <sub>CHZ</sub>	25	200	30	250	ns
Output disable time (OE)	t <sub>OHZ</sub>	25	200	30	250	ns
Output data hold time	t <sub>OH</sub>	10	_	15	_	ns

# 2. Write Cycle

# (1) 5-V operation

Table 11

(V<sub>CC</sub>=5 V±10%)

Parameter	Symbol	0°C to 70°C		-40°C 1	to 85°C	Unit
		Min.	Max.	Min.	Max.	
Write cycle time	t <sub>WC</sub>	_	10		10	ms
Address setup time	t <sub>AS</sub>	0	_	0	_	ns
Address hold time	t <sub>AH</sub>	120	_	150	_	ns
Write setup time	t <sub>CS</sub>	0	_	0	_	ns
Write hold time	t <sub>CH</sub>	0	_	0	_	ns
CE pulse width	t <sub>CW</sub>	120	_	150	_	ns
OE setup time	t <sub>OES</sub>	15	_	20	_	ns
OE hold time	t <sub>OEH</sub>	15	_	20	_	ns
WE pulse width	t <sub>WP</sub>	120	_	150	—	ns
Data setup time	t <sub>DS</sub>	85	_	100	_	ns
Data hold time	t <sub>DH</sub>	0	_	0	_	ns
Page load time	t <sub>PL</sub>	0.3	30	0.3	30	μs
(page data setting time)						
Page load time	t <sub>PDL</sub>	100		100		μs
(page data write start time)						
Time to device busy	$t_{DB}$	110	_	140		ns

## (2) 3-V operation (S-2812A only)

Table 12

(V<sub>CC</sub>=3 V±10%)

		<u>·</u>				
Parameter	Symbol	0°C to 70°C		-40°C to 85°C		Unit
		Min.	Max.	Min.	Max.	
Write cycle time	t <sub>WC</sub>	_	10	_	10	ms
Address setup time	t <sub>AS</sub>	0		0	_	ns
Address hold time	t <sub>AH</sub>	300	_	350		ns
Write setup time	t <sub>CS</sub>	0		0	_	ns
Write hold time	t <sub>CH</sub>	0		0	_	ns
CE pulse width	t <sub>CW</sub>	300		350	_	ns
OE setup time	t <sub>OES</sub>	30		35	_	ns
OE hold time	t <sub>OEH</sub>	30		35	_	ns
WE pulse width	t <sub>WP</sub>	300		350	_	ns
Data setup time	t <sub>DS</sub>	180		210	_	ns
Data hold time	$t_{DH}$	0	_	0	_	ns
Page load time	t <sub>PL</sub>	0.3	30	0.3	30	μs
(page data setting time)						
Page load time	$t_{PDL}$	100	_	100	_	μs
(page data write start time)						
Time to device busy	t <sub>DB</sub>	250	_	300	_	ns

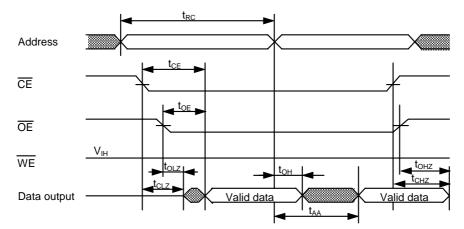


Figure 4 Read cycle

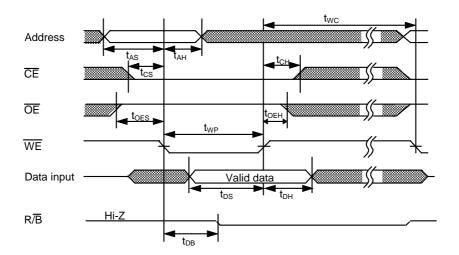


Figure 5 WE controlled write cycle

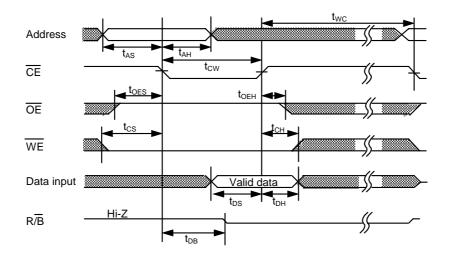


Figure 6 CE controlled write cycle

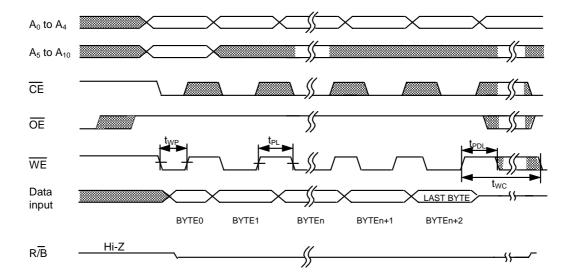


Figure 7 Page write cycle

## ■ Operation

### (1) Read mode

This mode outputs data to  $I/O_0$  to  $I/O_7$  when both  $\overline{CE}$  and  $\overline{OE}$  are low and when  $\overline{WE}$  is high. The data bus is high impedance when either  $\overline{CE}$  or  $\overline{OE}$  is high.

#### (2) Byte write mode

A byte write cycle starts when both  $\overline{\text{CE}}$  and  $\overline{\text{WE}}$  are low and  $\overline{\text{OE}}$  is high.  $\overline{\text{CE}}$ - and  $\overline{\text{WE}}$ -controlled write cycles are available. The address is latched at the falling of  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$  whichever occurs last, and the data is latched at the rising of  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$  whichever occurs first.

#### (3) Page write mode

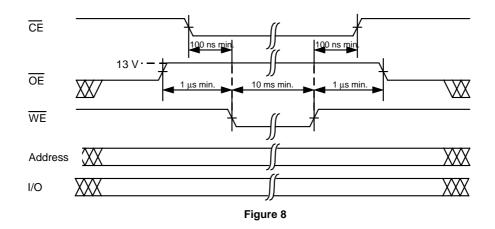
In this mode, 1 page program operation of 32 bytes is completed in 10 ms, and all memory area is written within a second because the device organization is 64-page  $\times$  32-byte. When starting this mode, first, addresses  $A_5$  to  $A_{10}$  assign the page, then  $A_0$  to  $A_4$  assign the address to each byte within the page sequencially or at random. Less than 32 bytes of program is available. This address assignment is performed while  $0.3 \ \mu s \le t_{PL} \le 30 \ \mu s$ , and the program operation starts when  $t_{PDL} \ge 100 \ \mu s$ .

### (4) Data polling

This function is to output the complement data written last on  $I/O_7$  and to output low to  $I/O_0$  to  $I/O_6$ . This operation is performed by read operation during write cycle.  $R/\overline{B}$  outputs low during write cycle; it is in high impedance in other modes.

#### (5) Erase all mode

All data is erased when  $\overline{OE}$  is 13 V and both  $\overline{CE}$  and  $\overline{WE}$  are low. During erase all mode,  $A_0$  to  $A_{10}$  and  $I/O_0$  to  $I/O_7$  must be fixed to either high or low.



## (6) Write inhibition

Write operation is inhibited in the following cases:

• When power supply voltage is under write inhibit voltage (V<sub>WI</sub>).

S-2817A: V<sub>WI</sub>=3.5 V typ.
S-2812A: V<sub>WI</sub>=2.1 V typ.
• When OE is low, or WE is high.

### (7) Program noise immunity

CE, OE and WE are noise protected for preventing erroneous write operation at power on and off. Less than 20 ns write pulse will not activate a write cycle at 5-V operation, and less than 50 ns at 3-V operation. See Figure 9.

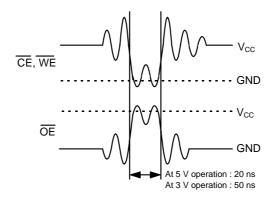


Figure 9

# ■ Dimensions (Unit : mm)

# 1. 28-pin DIP

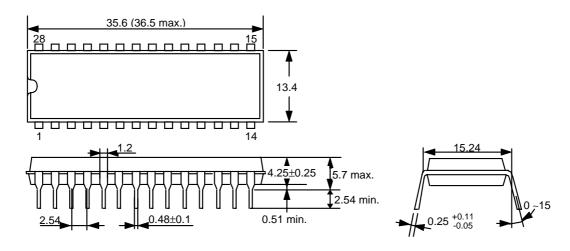


Figure 10

## 2. 28-pin SOP

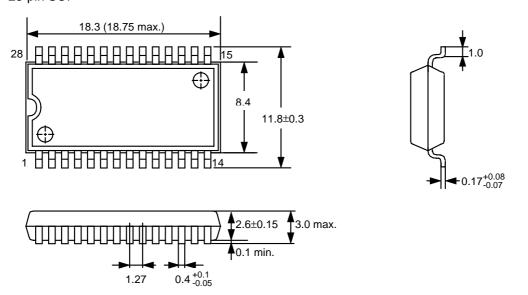


Figure 11

## 3. 28-pin TSOP

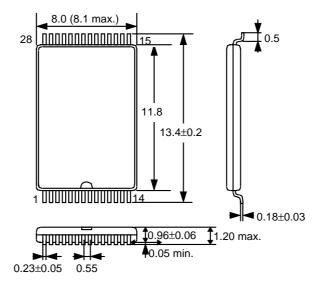
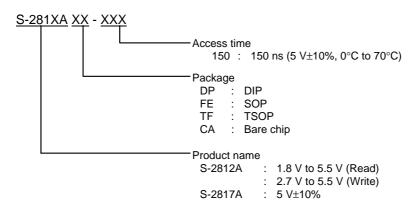


Figure 12

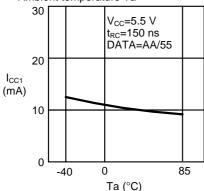
# ■ Ordering Information



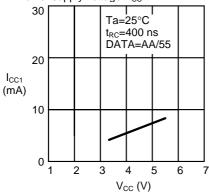
Note: Each bit is set to 1 before delivery (except bare chip)

### ■ Characteristics

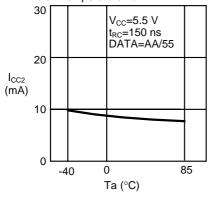
- 1. DC characteristics
  - 1.1 Current consumption (READ)  $I_{CC1}$  . Ambient temperature Ta



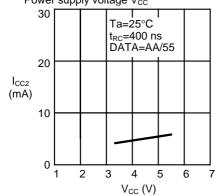
1.3 Current consumption (READ)  $I_{CC1}$  . Power supply voltage  $V_{CC}$ 



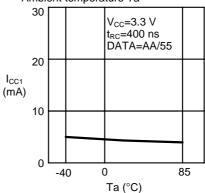
1.5 Current consumption (READ)  $I_{CC2}$  . Ambient temperature Ta



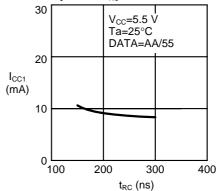
1.7 Current consumption (READ)  $I_{CC2}$  . Power supply voltage  $V_{CC}$ 



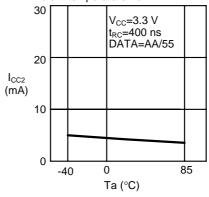
1.2 Current consumption (READ)  $I_{CC1}$  . Ambient temperature Ta



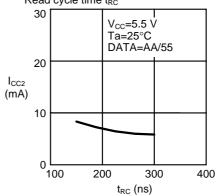
1.4 Current consumption (READ)  $I_{CC1}$  . Read cycle time  $t_{RC}$ 



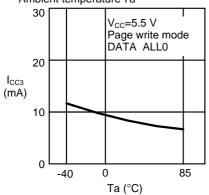
1.6 Current consumption (READ)  $I_{\text{CC2}}$  . Ambient temperature Ta



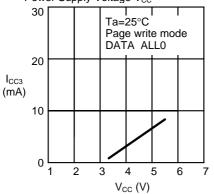
1.8 Current consumption (READ)  $I_{\text{CC2}}$  . Read cycle time  $t_{\text{RC}}$ 



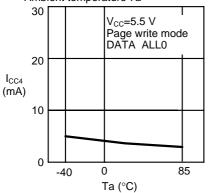
1.9 Current consumption (PROGRAM)  $I_{\text{CC3}}$  . Ambient temperature Ta



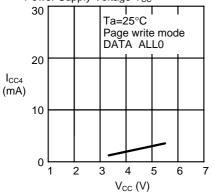
1.11 Current consumption (PROGRAM)  $I_{\text{CC3}}$  . Power Supply Voltage  $V_{\text{CC}}$ 



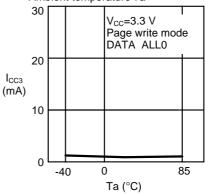
1.13 Current consumption (PROGRAM)  $I_{CC4}$  . Ambient temperature Ta



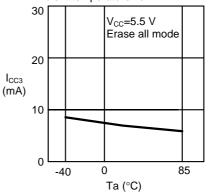
1.15 Current consumption (PROGRAM)  $I_{CC4}$  . Power Supply Voltage  $V_{CC}$ 



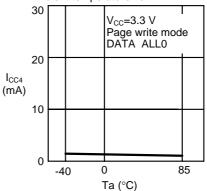
1.10 Current consumption (PROGRAM)  $I_{\text{CC3}}$  . Ambient temperature Ta



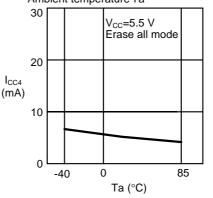
1.12 Current consumption (PROGRAM)  $I_{CC3}$  . Ambient temperature Ta



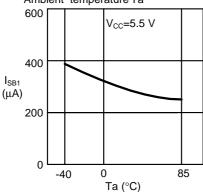
1.14 Current consumption (PROGRAM)  $I_{CC4}$  . Ambient temperature Ta



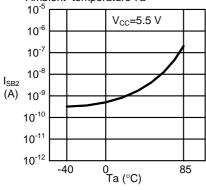
1.16 Current consumption (PROGRAM)  $I_{CC4}$  . Ambient temperature Ta



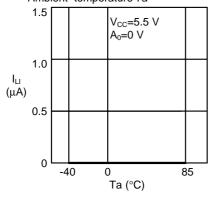
1.17 Standby current I<sub>SB1</sub> . Ambient temperature Ta



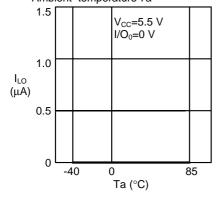
1.19 Standby current I<sub>SB2</sub> . Ambient temperature Ta



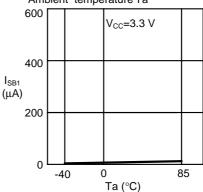
1.21 Input leakage current  $I_{LI}$ . Ambient temperature Ta



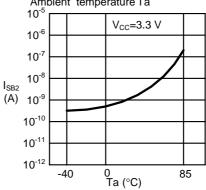
1.23 Output leakage current  $I_{LO}$ . Ambient temperature Ta



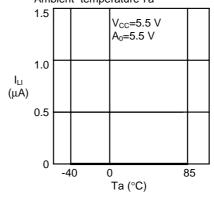
1.18 Standby current I<sub>SB1</sub> . Ambient temperature Ta



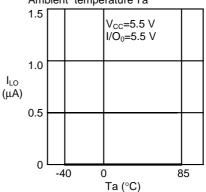
1.20 Standby current I<sub>SB2</sub> .
Ambient temperature Ta



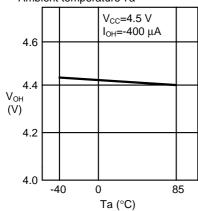
1.22 Input leakage current  $I_{LI}$ . Ambient temperature Ta



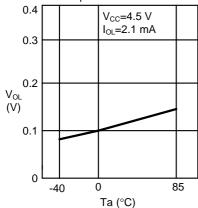
1.24 Output leakage current  $I_{LO}$  . Ambient temperature Ta



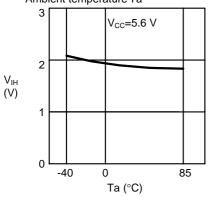
1.25 High level output voltage  $V_{\text{OH}}$  . Ambient temperature Ta



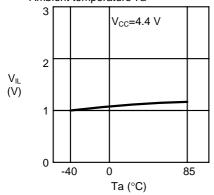
1.27 Low level output voltage  $V_{\text{OL}}$  . Ambient temperature Ta



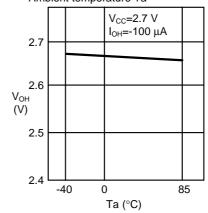
1.29 High level input voltage  $V_{\text{IH}}$  . Ambient temperature Ta



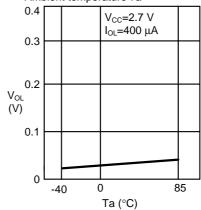
1.30 Low level input voltage V<sub>IL</sub> . Ambient temperature Ta



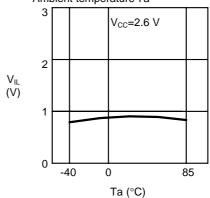
1.26 High level output voltage  $V_{\text{OH}}\,$  - Ambient temperature Ta



1.28 Low level output voltage  $V_{\text{OL}}$  . Ambient temperature Ta

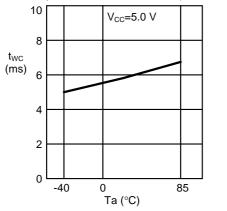


1.31 Low level input voltage  $V_{\text{IL}}$  . Ambient temperature Ta

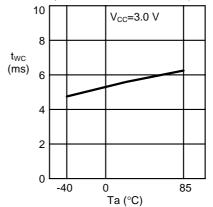


### 2. AC characteristics

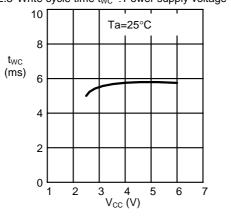
2.1 Write cycle time  $t_{\text{WC}}\,$  . Ambient temperature Ta



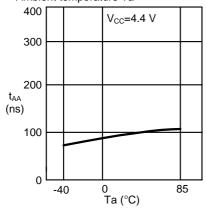
2.2 Write cycle time  $t_{\text{WC}}\,$  . Ambient temperature Ta



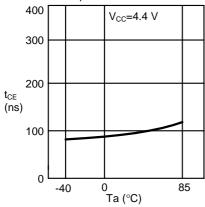
2.3 Write cycle time  $t_{\text{WC}}\,$  . Power supply voltage  $V_{\text{CC}}$ 



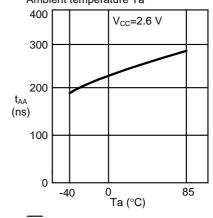
 $\begin{array}{c} \text{2.4 Address access time $t_{AA}$ .} \\ \text{Ambient temperature Ta} \end{array}$ 

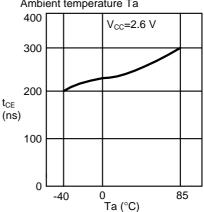


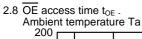
2.6 CE access time t<sub>CE</sub> .
Ambient temperature Ta

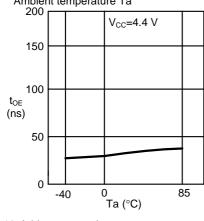


 $\begin{array}{c} \text{2.5 Address access time } t_{\text{AA}} \,. \\ \text{Ambient temperature Ta} \end{array}$ 

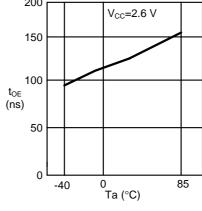




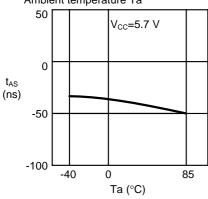




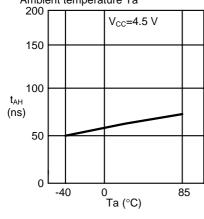
2.9 OE access time t<sub>OE</sub> .
Ambient temperature Ta



 $\begin{array}{c} \text{2.10 Address setup time $t_{\text{AS}}$.} \\ \text{Ambient temperature Ta} \end{array}$ 

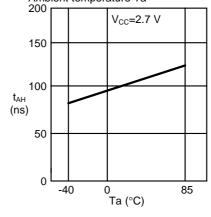


2.11 Address hold time t<sub>AH</sub> .
Ambient temperature Ta

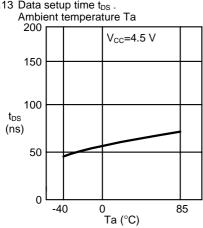


2.12 Address hold time t<sub>AH</sub> .

Ambient temperature Ta
200



2.13 Data setup time  $\ensuremath{t_{\text{DS}}}$  .



2.14 Data setup time t<sub>DS</sub> .

